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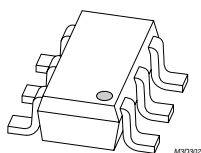
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Kind regards,

Team Nexperia



PMN23UN

μ TrenchMOS™ ultra low level FET

Rev. 01 — 16 June 2004

Product data

1. Product profile

1.1 Description

N-channel enhancement mode field-effect transistor in a plastic package using TrenchMOS™ technology.

1.2 Features

- TrenchMOS™ technology
- Very fast switching
- Low threshold voltage
- Surface mounted package.

1.3 Applications

- Battery powered motor control
- High-speed switch in set top box power supplies
- Load switch in notebook computers
- Driver FET in DC-to-DC converters.

1.4 Quick reference data

- $V_{DS} \leq 20$ V
- $P_{tot} \leq 1.75$ W
- $I_D \leq 6.3$ A
- $R_{DSon} \leq 28$ m Ω .

2. Pinning information

Table 1: Pinning - SOT457 (TSOP6), simplified outline and symbol

Pin	Description	Simplified outline	Symbol
1,2,5,6	drain (d)	<p>Top view MBK092</p>	<p>mbb076</p>
3	gate (g)		
4	source (s)		

SOT457 (TSOP6)



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3. Ordering information

Table 2: Ordering information

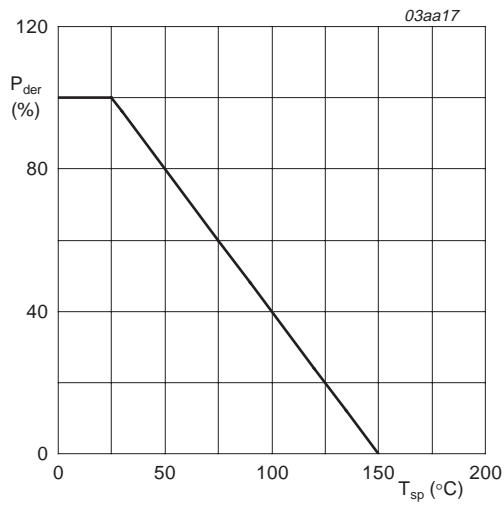
Type number	Package		Version
	Name	Description	
PMN23UN	TSOP6	Plastic surface mounted package; 6 leads	SOT457

4. Limiting values

Table 3: Limiting values

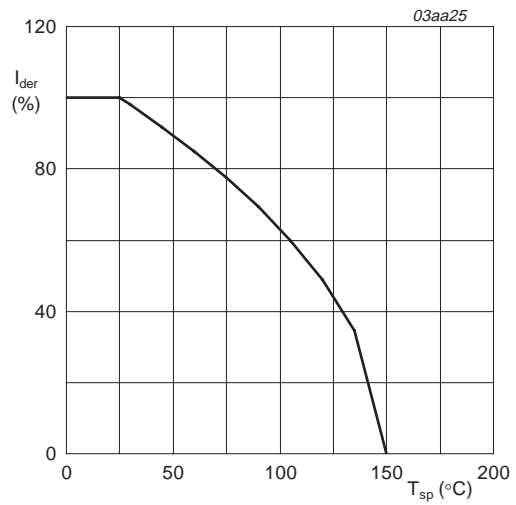
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage (DC)	$25\text{ °C} \leq T_j \leq 150\text{ °C}$	-	20	V
V_{GS}	gate-source voltage (DC)		-	± 8	V
I_D	drain current (DC)	$T_{sp} = 25\text{ °C}; V_{GS} = 4.5\text{ V};$ Figure 2 and 3	-	6.3	A
		$T_{sp} = 70\text{ °C}; V_{GS} = 4.5\text{ V};$ Figure 2	-	5	A
I_{DM}	peak drain current	$T_{sp} = 25\text{ °C};$ pulsed; $t_p \leq 10\text{ }\mu\text{s};$ Figure 3	-	25.2	A
P_{tot}	total power dissipation	$T_{sp} = 25\text{ °C};$ Figure 1	-	1.75	W
T_{stg}	storage temperature		-55	+150	°C
T_j	junction temperature		-55	+150	°C
Source-drain diode					
I_S	source (diode forward) current (DC)	$T_{sp} = 25\text{ °C}$	-	1.45	A



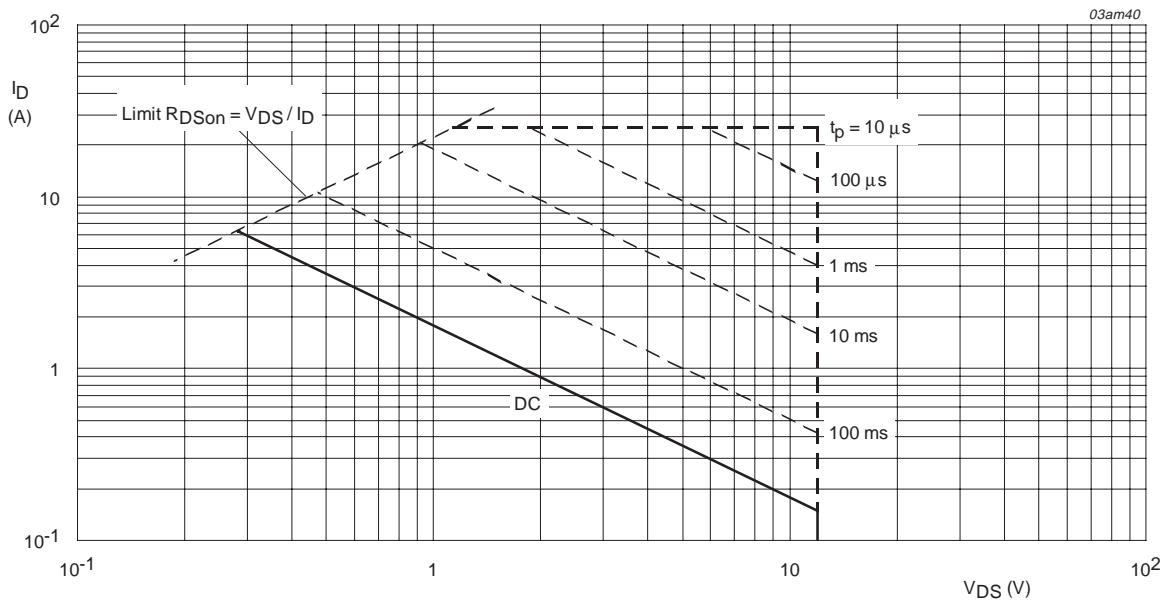
$$P_{der} = \frac{P_{tot}}{P_{tot(25^{\circ}C)}} \times 100\%$$

Fig 1. Normalized total power dissipation as a function of solder point temperature.



$$I_{der} = \frac{I_D}{I_{D(25^{\circ}C)}} \times 100\%$$

Fig 2. Normalized continuous drain current as a function of solder point temperature.



T_{sp} = 25 °C; I_{DM} is single pulse.

Fig 3. Safe operating area; continuous and peak drain currents as a function of drain-source voltage.

5. Thermal characteristics

Table 4: Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$R_{th(j-sp)}$	thermal resistance from junction to solder point	Figure 4	-	-	70	K/W

5.1 Transient thermal impedance

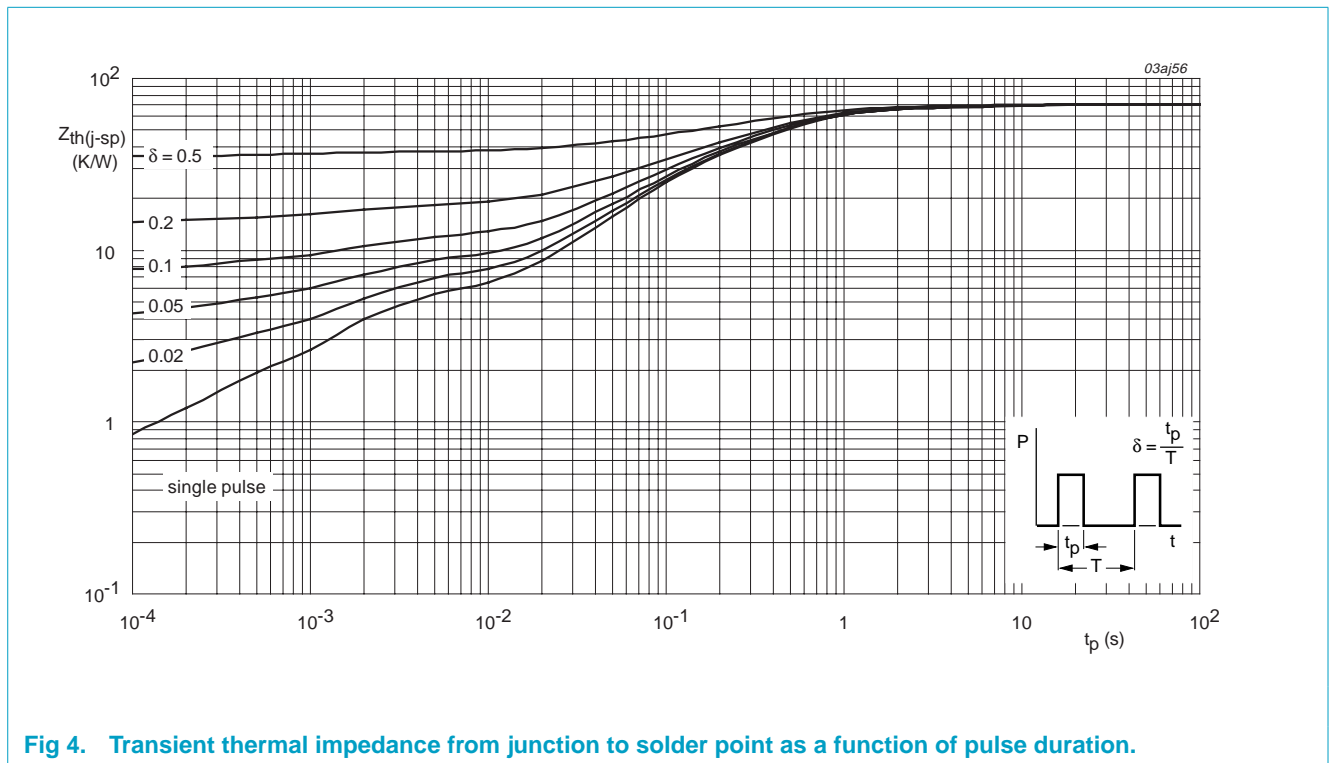


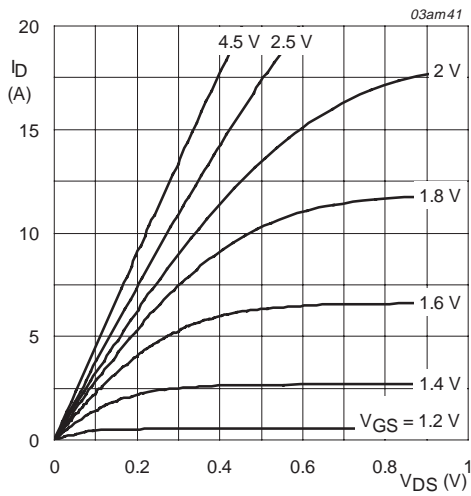
Fig 4. Transient thermal impedance from junction to solder point as a function of pulse duration.

6. Characteristics

Table 5: Characteristics

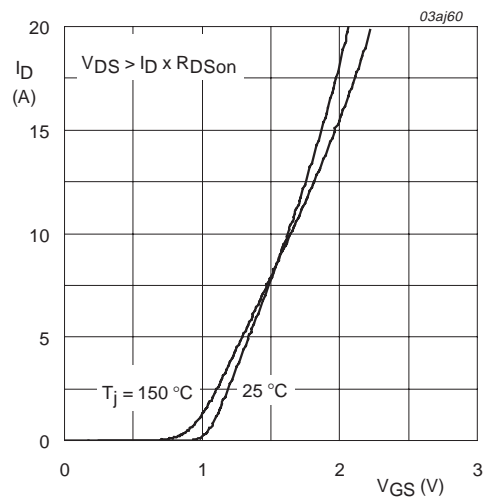
$T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static characteristics						
$V_{(BR)DSS}$	drain-source breakdown voltage	$I_D = 250\ \mu\text{A}$; $V_{GS} = 0\ \text{V}$	20	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	$I_D = 1\ \text{mA}$; $V_{DS} = V_{GS}$; Figure 9 and 10	0.4	0.7	-	V
I_{DSS}	drain-source leakage current	$V_{DS} = 16\ \text{V}$; $V_{GS} = 0\ \text{V}$ $T_j = 25\text{ }^\circ\text{C}$	-	0.01	1.0	μA
			-	-	10	μA
			-	-	-	-
I_{GSS}	gate-source leakage current	$V_{GS} = \pm 8\ \text{V}$; $V_{DS} = 0\ \text{V}$	-	10	100	nA
$R_{DS(on)}$	drain-source on-state resistance	$V_{GS} = 4.5\ \text{V}$; $I_D = 2\ \text{A}$; Figure 7 and 8	-	23	28	$\text{m}\Omega$
		$V_{GS} = 2.5\ \text{V}$; $I_D = 2\ \text{A}$; Figure 7 and 8	-	29	34.4	$\text{m}\Omega$
		$V_{GS} = 1.8\ \text{V}$; $I_D = 1.5\ \text{A}$; Figure 7 and 8	-	37	52	$\text{m}\Omega$
Dynamic characteristics						
$Q_{g(tot)}$	total gate charge	$V_{DD} = 10\ \text{V}$; $V_{GS} = 4.5\ \text{V}$; $I_D = 3.8\ \text{A}$; Figure 13	-	10.6	-	nC
Q_{gs}	gate-source charge		-	1.8	-	nC
Q_{gd}	gate-drain (Miller) charge		-	2.1	-	nC
C_{iss}	input capacitance	$V_{GS} = 0\ \text{V}$; $V_{DS} = 10\ \text{V}$; $f = 1\ \text{MHz}$; Figure 11	-	740	-	pF
C_{oss}	output capacitance		-	185	-	pF
C_{riss}	reverse transfer capacitance		-	125	-	pF
$t_{d(on)}$	turn-on delay time	$V_{DD} = 10\ \text{V}$; $R_L = 10\ \Omega$; $V_{GS} = 4.5\ \text{V}$; $R_G = 6\ \Omega$	-	8.5	-	ns
t_r	rise time		-	14.5	-	ns
$t_{d(off)}$	turn-off delay time		-	55	-	ns
t_f	fall time		-	16	-	ns
Source-drain diode						
V_{SD}	source-drain (diode forward) voltage	$I_S = 1.7\ \text{A}$; $V_{GS} = 0\ \text{V}$; Figure 12	-	0.8	1.2	V



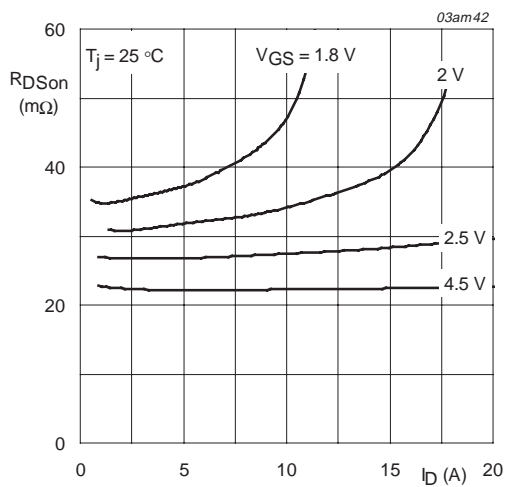
$T_j = 25\text{ °C}$

Fig 5. Output characteristics: drain current as a function of drain-source voltage; typical values.



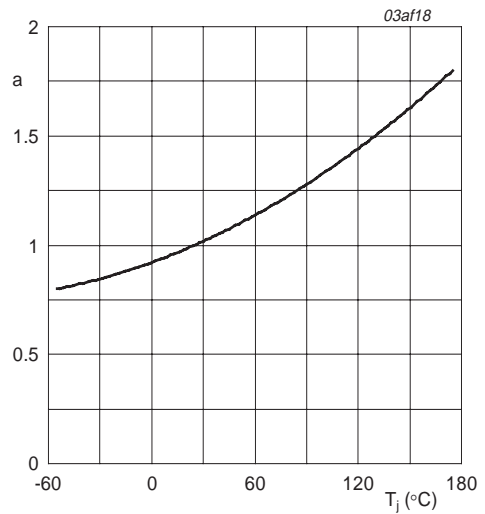
$T_j = 25\text{ °C}$ and 150 °C ; $V_{DS} > I_D \times R_{DSon}$

Fig 6. Transfer characteristics: drain current as a function of gate-source voltage; typical values.



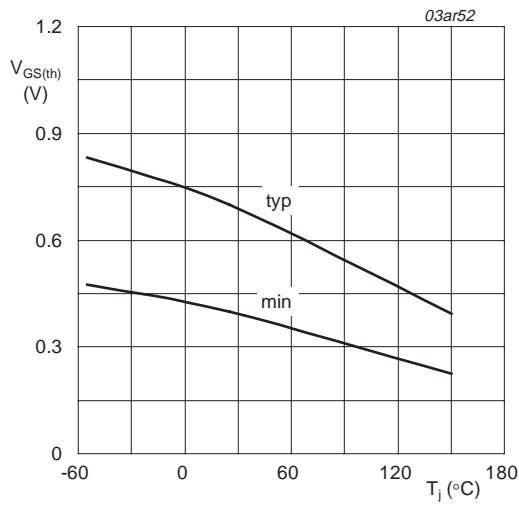
$T_j = 25\text{ °C}$

Fig 7. Drain-source on-state resistance as a function of drain current; typical values.



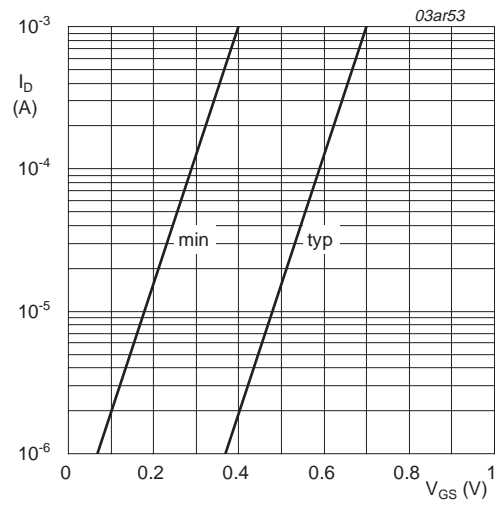
$$a = \frac{R_{DSon}}{R_{DSon(25^{\circ}\text{C})}}$$

Fig 8. Normalized drain-source on-state resistance factor as a function of junction temperature.



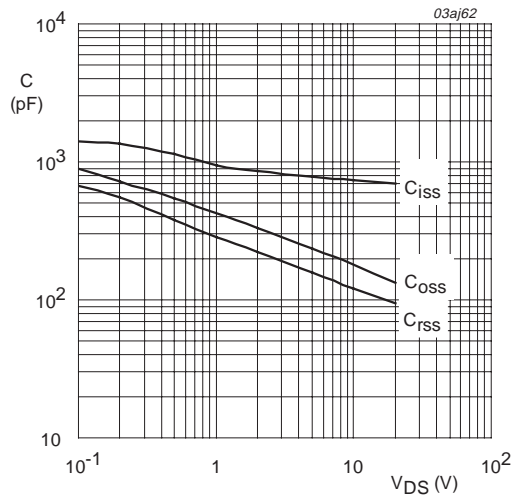
$I_D = 1 \text{ mA}; V_{DS} = V_{GS}$

Fig 9. Gate-source threshold voltage as a function of junction temperature.



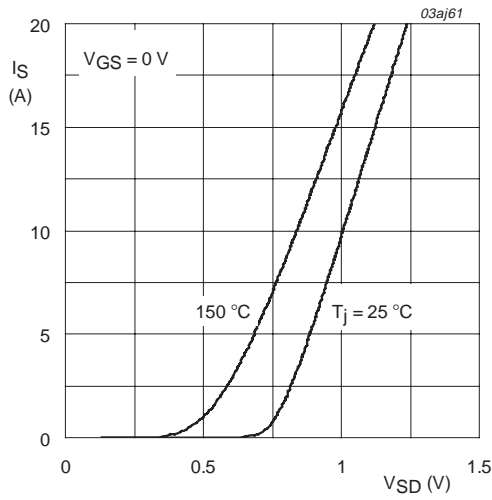
$T_j = 25 \text{ °C}; V_{DS} = 5 \text{ V}$

Fig 10. Sub-threshold drain current as a function of gate-source voltage.



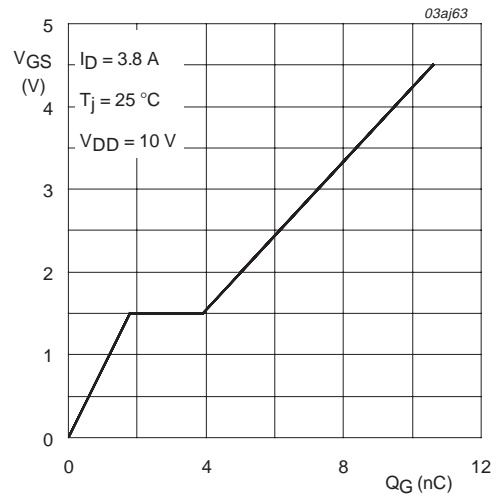
$V_{GS} = 0 \text{ V}; f = 1 \text{ MHz}$

Fig 11. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values.



$T_j = 25\text{ }^\circ\text{C}$ and $150\text{ }^\circ\text{C}$; $V_{GS} = 0\text{ V}$

Fig 12. Source (diode forward) current as a function of source-drain (diode forward) voltage; typical values.



$I_D = 3.8\text{ A}$; $V_{DD} = 10\text{ V}$

Fig 13. Gate-source voltage as a function of gate charge; typical values.

7. Package outline

Plastic surface mounted package; 6 leads

SOT457

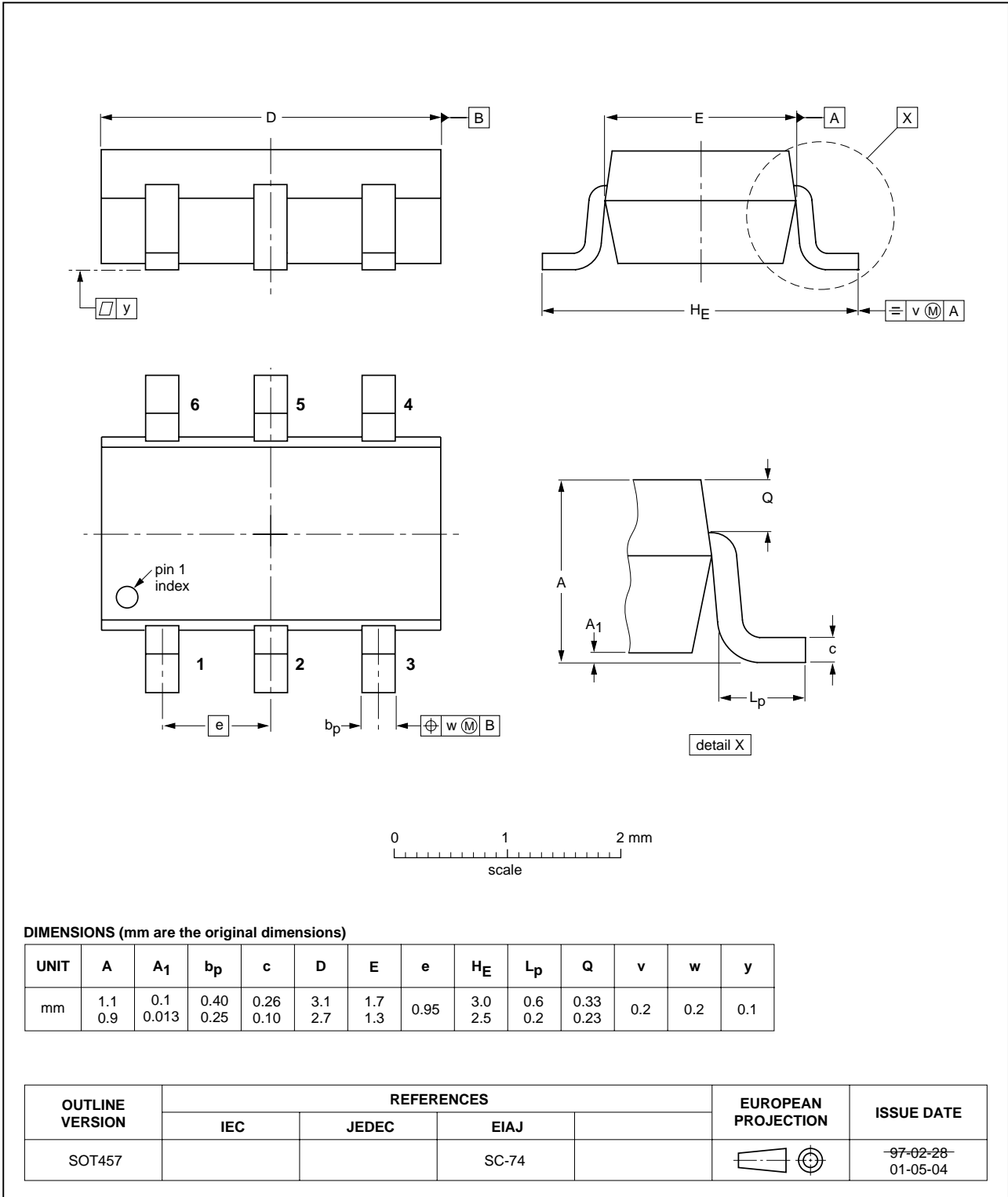


Fig 14. SOT457 (TSOP6).

8. Revision history

Table 6: Revision history

Rev	Date	CPCN	Description
01	20040616	-	Product data (9397 750 13351)

9. Data sheet status

Level	Data sheet status ^[1]	Product status ^{[2][3]}	Definition
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
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[1] Please consult the most recently issued data sheet before initiating or completing a design.

[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL <http://www.semiconductors.philips.com>.

[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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Date of release: 16 June 2004

Document order number: 9397 750 13351



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